

MBR2535CT - MBR2560CT

30A SCHOTTKY BARRIER RECTIFIER

Features

- Schottky Barrier Chip
- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- High Surge Capability
- High Current Capability and Low Forward Voltage Drop
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- Lead Free Finish, RoHS Compliant (Note 4)

Mechanical Data

- Case: TO-220AB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Bright Tin. Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Marking: Type Number
- Weight: 2.24 grams (approx.)



TO-220AB					
Dim	Min	Max			
Α	14.48	15.75			
В	10.00	10.40			
С	2.54	3.43			
D	5.90	6.40			
E	2.80	3.93			
G	12.70	14.27			
н	2.40	2.70			
J	0.69	0.93			
к	3.54	3.78			
L	4.07	4.82			
м	1.15	1.39			
N	0.30	0.50			
Р	2.04	2.79			
All Dimensions in mm					

Maximum Ratings and Electrical Characteristics @ T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	MBR2535CT	MBR2545CT	MBR2550CT	MBR2560CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		35	45	50	60	V
RMS Reverse Voltage	V _{R(RMS)}	25	32	35	42	V
Average Rectified Output Current $@ T_C = 130^{\circ}C$		30				А
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)		150			A	
Peak Repetitive Reverse Surge Current (Note 3)		1.0 0.5		.5	А	
Forward Voltage Drop (a) $I_F = 15.0A, T_C = 25^{\circ}(C)$ (b) $I_F = 15.0A, T_C = 125^{\circ}(C)$ (c) $I_F = 30.0A, T_C = 25^{\circ}(C)$ (c) $I_F = 30.0A, T_C = 125^{\circ}(C)$ (c) $I_F = 30.0A, T_C = 125^{\circ}(C)$	V _{FM}	 0. 0.	 82 73	0. 0. 	75 65 —	V
$\begin{array}{llllllllllllllllllllllllllllllllllll$		0.2 40		1.0 50		mA
Typical Total Capacitance (Note 2)		7!	50	50	00	pF
Typical Thermal Resistance Junction to Case (Note 1)		1.5			°C/W	
Operating and Storage Temperature Range		-65 to +150			°C	

Notes: 1. Thermal resistance junction to case mounted on heatsink.

2. Measured at 1.0MHz and Applied Reverse Voltage of 4.0V DC.

3. 2.0 μ s pulse width, f = 1.0KHz.

4. RoHS revision 13.2.2003. Glass and High Temperature Solder Exemptions Applied, see EU Directive Annex Notes 5 and 7.



Ordering Information (Note 5)

Device	Packaging	Shipping
MBR25xxCT*	TO-220AB	50/Tube

* xx = Device type, e.g. MBR2545CT

Notes: 4. For packaging details, visit our website at http://www.diodes.com/datasheets/ap02008.pdf.